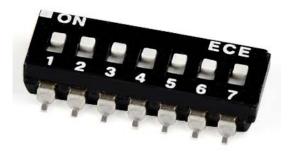


EAD SERIES AUTO INSERTING SMT TYPE



FEATURES

- Same size with IC, can be assembled by any automatic IC inserter.
- Molded 0.3" integrated circuit packing outline allowing automatic insertion.
- Smaller size makes better heat convection during PC board reflow wave soldering.
- Top tape sealed to withstand wave soldering, board washing.
- All plastics are UL 94V-0 grade fire retardant.
- Gold plated contact to ensure low contact resistance and Tin plated terminals to prevent contamination during soldering.
- RoHS Compliant

APPLICATIONS

- Numerical setting for computer terminal equipment
- Price setting for vending machines
- Programming for game machines
- Programming for industrial equipment and measuring instruments

SPECIFICATIONS

1.ELECTRICAL

 Contact rating 	switching	25mA, 24VDC		
	non-switching	100mA		
 Contact resistance 	initial	50mΩ Max.		
	after life test	100mΩ Max.		
Insulation resistance		1000MΩ Min. at 100VDC		
Dielectric strength		500VDC Min. for 60 seconds		
Capacitance between adjacent switches 5pF Max.				

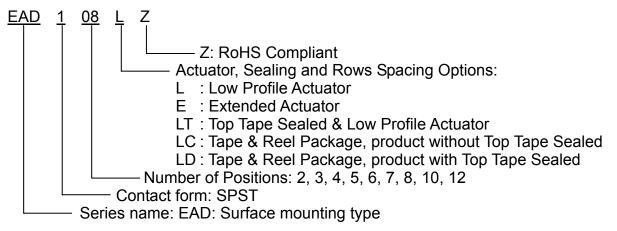
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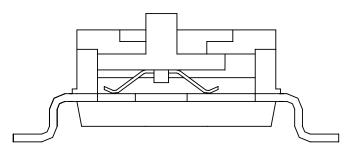
2.MECHANICAL and ENVIRONMENTAL

• Temperature rating	operating	-40°℃ to +85°℃		
	storage	-40℃ to +85℃		
Operation force		800g Max.		
 Mechanical life 		2000 operations		
Humidity		95% RH, 40°C for 96 Hrs.		
Vibration		0Hz-55Hz-10Hz for 6 Hrs.		
 Resistance to soldering heat 		Solder reflow : peak temperature 260°C Max.		
 Reflow soldering process for SMT type 		Reference ICE 61760		

PART NUMBERING SYSTEM







OPTIONS

1.Special marking is available 2.Extended Actuator 3.Top Tape Sealed





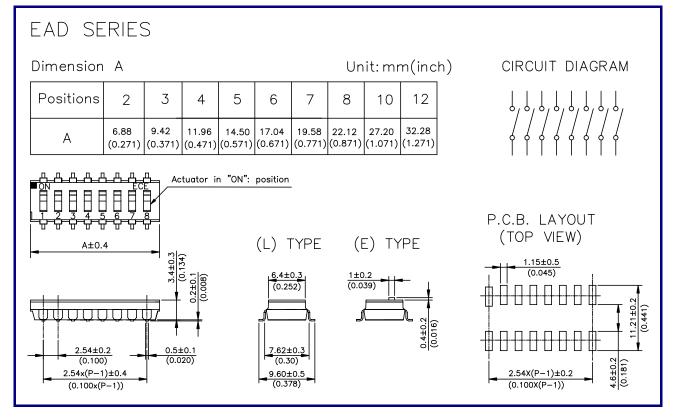
PACKAGING

1.Tape & Reel Packaging (per EIA STANDARD)

, Feed	For 3P-6P Direction of feed		
Direction of Feed	$\left \begin{array}{c} \Phi & \Phi $	TYPE	No. of pcs per reel
Olli		2P	1300
		3P	1000
		4P	1000
		5P	1000
	For 7P-12P Direction of feed	6P	1000
			1000
For 2P Direction of feed		8P	1000
/		9P	1000
		10P	1000
		12P	1000

DIMENSIONS AND CIRCUITRY

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Switch

4